

Data Sheet August 1999 File Number 3624.2

## Low Power, High Performance Radiation Hardened Operational Amplifier

HS-2700RH is radiation hardened internally compensated operational amplifiers which employ dielectric isolation to achieve excellent DC and dynamic performance with very low quiescent power consumption.

DC performance of the amplifier input is characterized by high CMRR (106dB), low offset voltage (0.5mV), along with low bias and offset current (5.0nA and 2.5nA respectively). These input specifications, in conjunction with offset null capability and open-loop gain of 300,000V/V, enable HS-2700RH to provide accurate, high-gain signal amplification. Gain bandwidth 1MHz and slew rate of  $20V/\mu s$  allow for processing of fast, wideband signals. Input and output signal amplitudes of at least  $\pm 11V$  can be accommodated while providing output drive capability of 10mA. For maximum reliability, the output is protected in the event of short circuits to ground.

The amplifier operates from a wide range of supplies ( $\pm 5.5$ V to  $\pm 20$ V) with a maximum quiescent supply drain of only 150 $\mu$ A. HS-2700RH is therefore, ideally suited to low-power instrumentation and filtering applications that require fast, accurate response over a wide range of signal frequency.

Specifications for Rad Hard QML devices are controlled by the Defense Supply Center in Columbus (DSCC). The SMD numbers listed here must be used when ordering.

Detailed Electrical Specifications for these devices are contained in SMD 5962-95670. A "hot-link" is provided on our homepage for downloading. www.intersil.com/spacedefense/space.asp

#### **Features**

- Electrically Screened to SMD # 5962-95670
- QML Qualified per MIL-PRF-38535 Requirements

•	Low Power Supply Current	150μΑ (Max) 90μΑ (Typ)
•	High CMRR	86dB (Min) 106dB (Typ)
•	Low Input Bias Current	20nA (Min)

- Total Dose ......1 x 10<sup>4</sup> RAD(Si)

## **Applications**

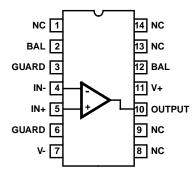
- · High Gain Amplifier
- Instrumentation Amplifiers
- Active Filters
- · Telemetry Systems
- · Battery-Powered Equipment

# Ordering Information

ORDERING NUMBER	INTERNAL MKT. NUMBER	TEMP. RANGE (°C)
5962D9567002VCA	HS1-2700RH-Q	-55 to 125
5962D9567002VCC	HS1B-2700RH-Q	-55 to 125
5962D9567002VGA	HS2-2700RH-Q	-55 to 125

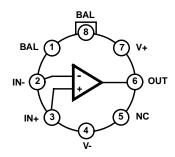
## **Pinouts**

HS1-2700RH (CERDIP) GDIP1-T14 OR HS1B-2700RH (SBDIP) CDIP2-T14 TOP VIEW

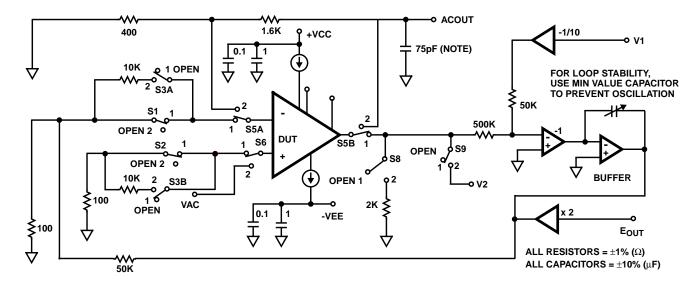


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HS2-2700RH (CAN) MACY1-X8 TOP VIEW



## **Test Circuit**



NOTE: Includes stray capacitances.

## **Timing Waveforms**

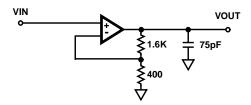


FIGURE 1. SIMPLIFIED TEST CIRCUIT

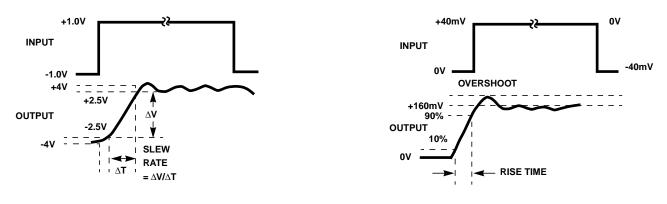


FIGURE 2. SLEW RATE WAVEFORM

FIGURE 3. TRANSIENT RESPONSE WAVEFORM

NOTE: Measured on both positive and negative transitions. Capacitance at Compensation pin should be minimized.

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## Typical Performance Curves TA = 25°C, VSUPPLY = ±15V, Unless Otherwise Specified

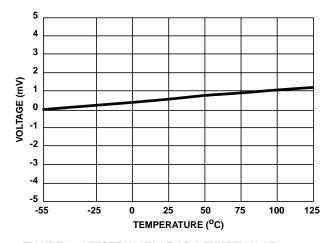
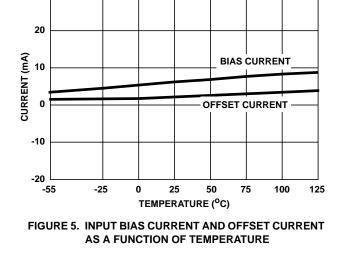


FIGURE 4. OFFSET VOLTAGE AS A FUNCTION OF TEMPERATURE



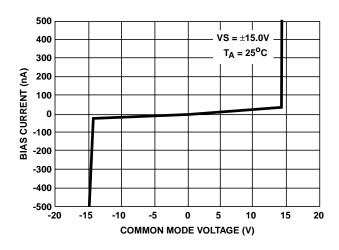


FIGURE 6. BIAS CURRENT AS A FUNCTION OF COMMON MODE VOLTAGE

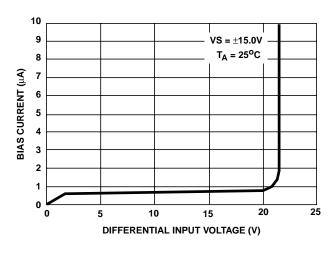


FIGURE 7. BIAS CURRENT AS A FUNCTION OF DIFFERENTIAL INPUT VOLTAGE

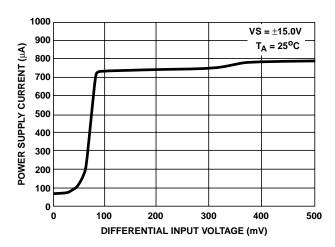


FIGURE 8. POWER SUPPLY CURRENT AS A FUNCTION OF DIFFERENTIAL INPUT VOLTAGE

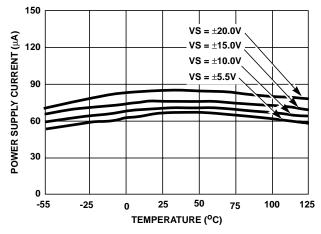


FIGURE 9. POWER SUPPLY CURRENT AS A FUNCTION OF TEMPERATURE

# $\textbf{\textit{Typical Performance Curves}} \ \ T_{A} = 25^{o}\text{C, VSUPPLY} = \ \pm 15\text{V, Unless Otherwise Specified (Continued)}$

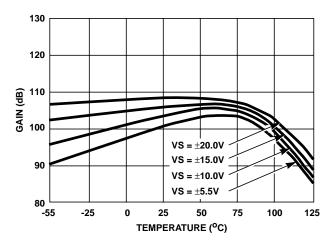
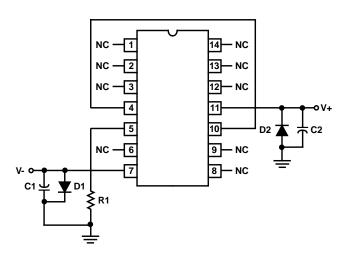


FIGURE 10. VOLTAGE GAIN AS A FUNCTION OF TEMPERATURE

NOTE: Open loop (comparator) applications are not recommended, because of the above characteristic.

## **Burn-In Circuits**

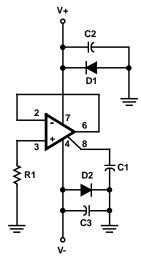
## HS1-2700RH CERDIP



## NOTES:

- 1. R1 =  $1M\Omega$ ,  $\pm 5\%$ , 1/4W (Min)
- 2.  $C1 = C2 = 0.01 \mu F/Socket$  (Min) or  $0.1 \mu F/Row$  (Min)
- 3. D1 = D2 = 1N4002 or equivalent (per board)
- 4.  $|(V+) (V-)| = 31V \pm 1V$

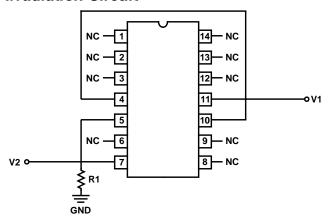
## **HS2-2700RH METAL CAN**



## NOTES:

- 5. R1 =  $1M\Omega$ ,  $\pm 5\%$ , 1/4W (Min)
- 6.  $C1 = 0.01 \mu F/Socket (Min)$
- 7.  $C2 = C3 = 0.01 \mu F/Socket$  (Min) or  $0.1 \mu F/Row$  (Min)
- 8. D1 = D2 = 1N4002 or equivalent (per board)
- 9.  $|(V+) (V-)| = 31V \pm 1V$
- 10. Insulated scope probe must be used during board check-out.

# Irradiation Circuit



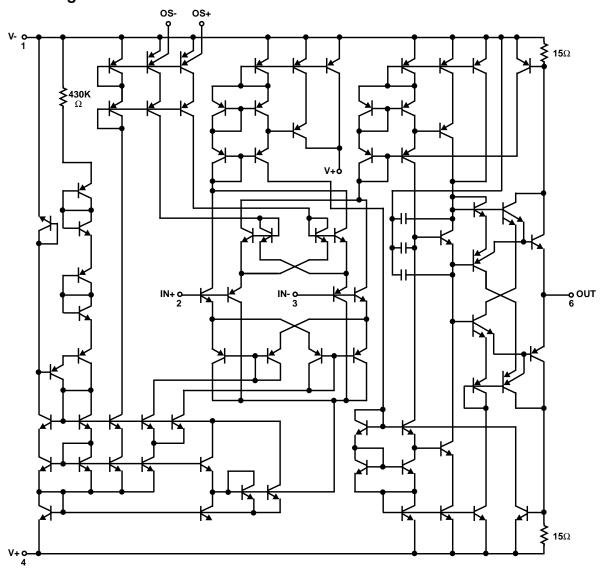
## NOTES:

11.  $R = 1M\Omega, \pm 5\%, 1/4W$ 

12. V1 = +15V + 1.0V

13. V2 = -15V + 1.0V

# Schematic Diagram



NOTE: Nominal currents shown in microamperes.

## Die Characteristics

## **DIE DIMENSIONS:**

70 mils x 60 mils x 20 mils (1780 $\mu$ m x 1530 $\mu$ m x 1530 $\mu$ m)

## **INTERFACE MATERIALS:**

## Glassivation:

Type: Nitride

Thickness: 7kÅ ±0.7kÅ

## **Top Metallization:**

Type: Aluminum Thickness: 16kÅ ±2kÅ

## Substrate:

Linear Bipolar, DI

#### **Backside Finish:**

Silicon

## Metallization Mask Layout

## **ASSEMBLY RELATED INFORMATION:**

Substrate Potential (Powered Up):

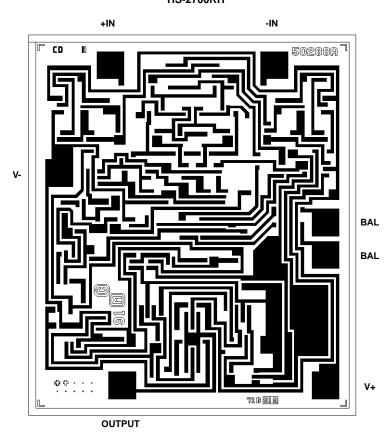
Unbiased

## ADDITIONAL INFORMATION:

## **Worst Case Current Density:**

 $< 2 \times 10^5 \text{ A/cm}^2$ 

HS-2700RH



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